

High Efficient Surface Mount Rectifiers

FEATURES

- Low power loss, high efficiency
- Ideal for automated placement
- Glass passivated junction chip.
- Fast switching for high efficiency
- Moisture sensitivity level: level 1, per J-STD-020
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21 definition



MECHANICAL DATA

Case: DO-214AA (SMB)

Molding compound, UL flammability classification rating 94V-0

Base P/N with suffix "G" on packing code - green compound (halogen-free)

Base P/N with prefix "H" on packing code - AEC-Q101 qualified

Terminal: Matte tin plated leads, solderable per JESD22-B102

Meet JESD 201 class 1A whisker test

with prefix "H" on packing code meet JESD 201 class 2 whisker test

Polarity: Indicated by cathode band

Weight: 0.093 g (approximately)

DO-214AA (SMB)

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS (T _A =25°C unless otherwise noted)										
PARAMETER	SYMBOL	HS 2A	HS 2B	HS 2D	HS 2F	HS 2G	HS 2J	HS 2K	HS 2M	UNIT
Maximum repetitive peak reverse voltage	V _{RRM}	50	100	200	300	400	600	800	1000	V
Maximum RMS voltage	V _{RMS}	35	70	140	210	280	420	560	700	V
Maximum DC blocking voltage	V _{DC}	50	100	200	300	400	600	800	1000	V
Maximum average forward rectified current	I _{F(AV)}	2								A
Peak forward surge current, 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	50								A
Maximum instantaneous forward voltage (Note 1) I _F = 2 A	V _F	1.0			1.3		1.7			V
Maximum reverse current @ rated VR T _J = 25 °C T _J = 125 °C	I _R	5 150								μA
Maximum reverse recovery time (Note 2)	T _{rr}	50				75				ns
Typical junction capacitance (Note 3)	C _j	50				30				pF
Typical thermal resistance	R _{θJA}	80								°C/W
Operating junction temperature range	T _J	- 55 to +150								°C
Storage temperature range	T _{STG}	- 55 to +150								°C

Note 1: Pulse test with PW=300μs, 1% duty cycle

Note 2: Reverse Recovery Test Conditions: I_F=0.5A, I_R=1.0A, I_{RR}=0.25A

Note 3: Measured at 1 MHz and Applied V_R=4.0 Volts

ORDERING INFORMATION					
PART NO.	AEC-Q101 QUALIFIED	PACKING CODE	GREEN COMPOUND CODE	PACKAGE	PACKING
HS2x (Note 1)	Prefix "H"	R5	Suffix "G"	SMB	850 / 7" Plastic reel
		R4		SMB	3,000 / 13" Paper reel
		M4		SMB	3,000 / 13" Plastic reel

Note 1: "x" defines voltage from 50V (HS2A) to 1000V (HS2M)

EXAMPLE					
PREFERRED P/N	PART NO.	AEC-Q101 QUALIFIED	PACKING CODE	GREEN COMPOUND CODE	DESCRIPTION
HS2M R5	HS2M		R5		
HS2M R5G	HS2M		R5	G	Green compound
HS2MHR5	HS2M	H	R5		AEC-Q101 qualified

RATINGS AND CHARACTERISTICS CURVES

(TA=25°C unless otherwise noted)

FIG. 1- MAXIMUM FORWARD CURRENT DERATING CURVE

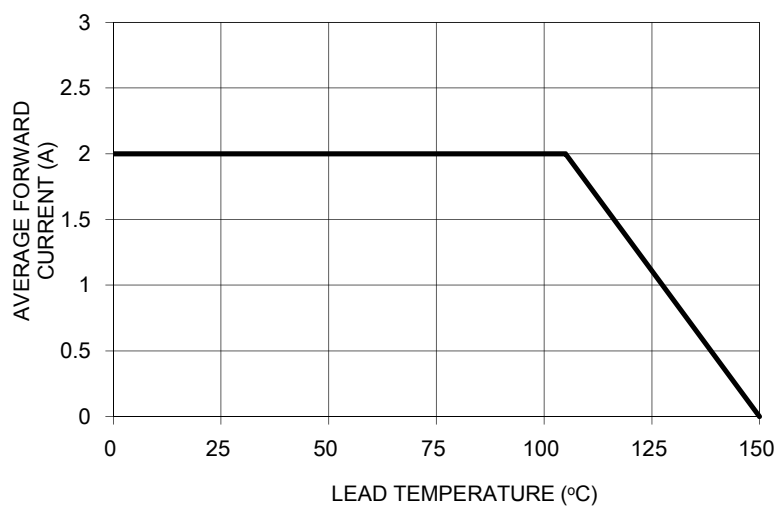


FIG. 2- TYPICAL REVERSE CHARACTERISTICS

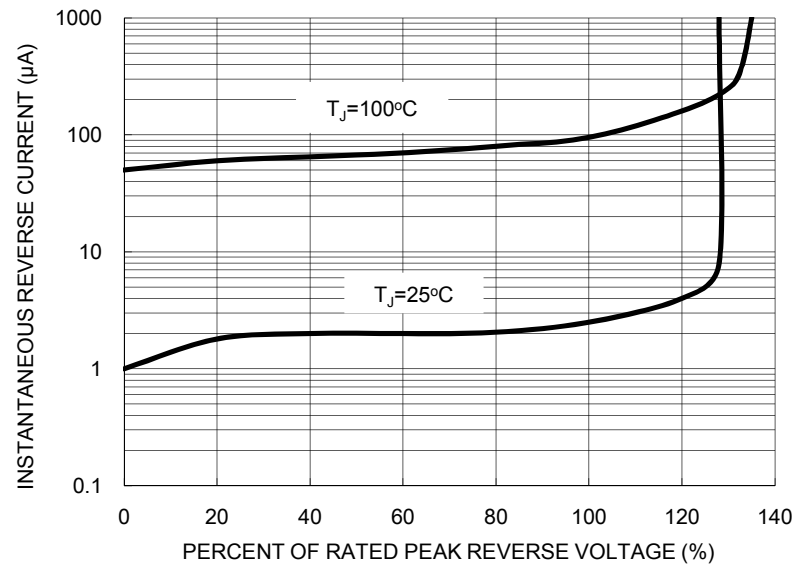


FIG. 3- MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

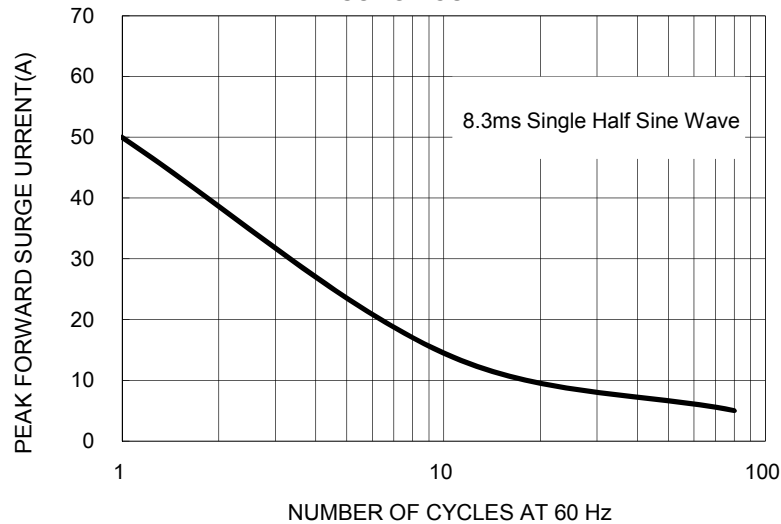


FIG. 5- TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

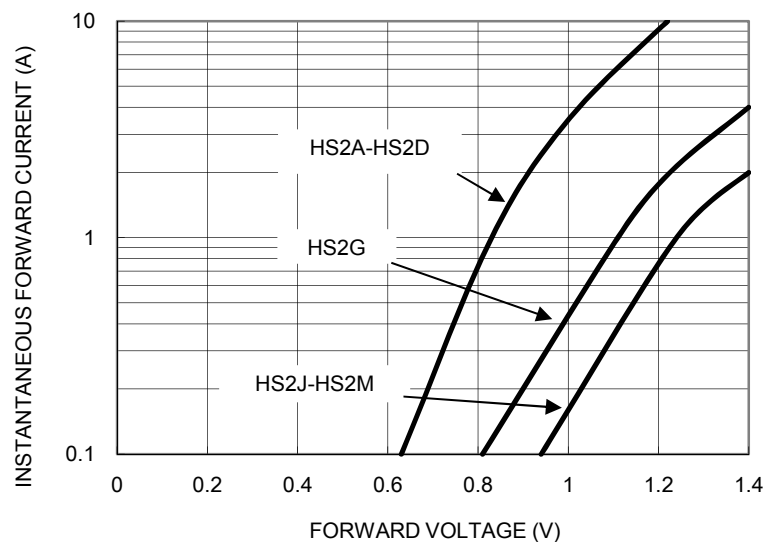


FIG. 4- TYPICAL JUNCTION CAPACITANCE

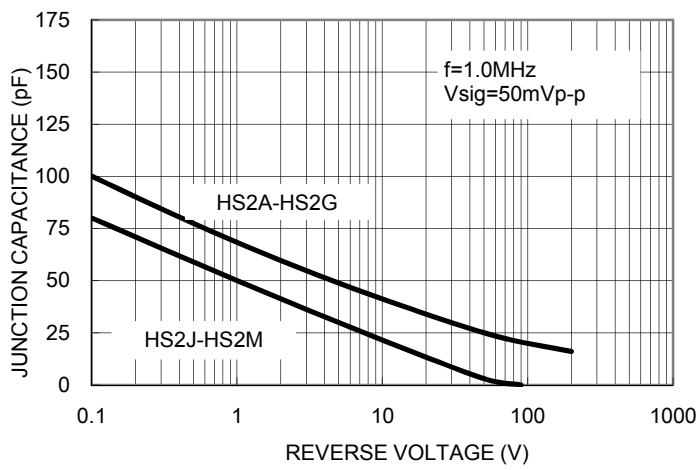
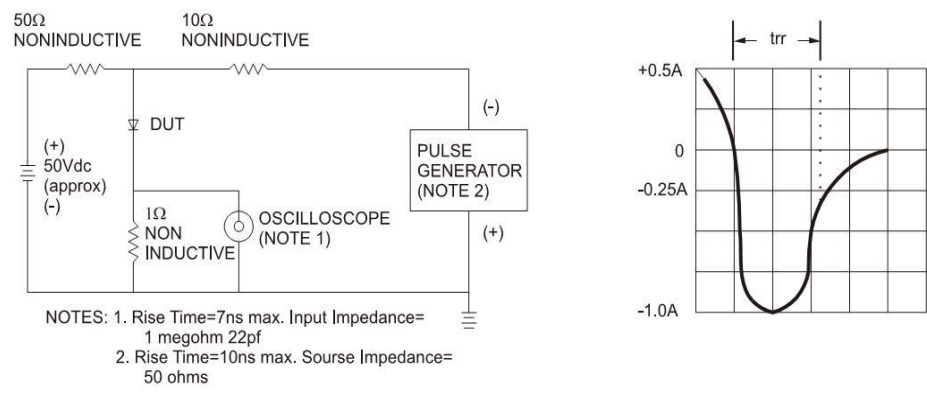
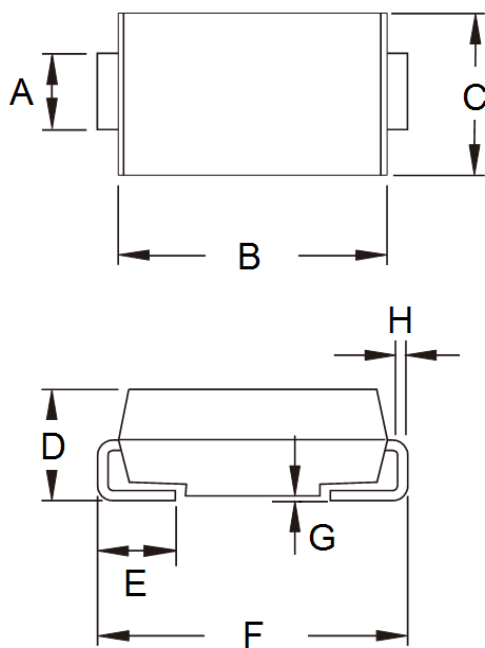


FIG.6- REVERSE RECOVERY TIME CHARACTERISTIC AND TEST CIRCUIT DIAGRAM



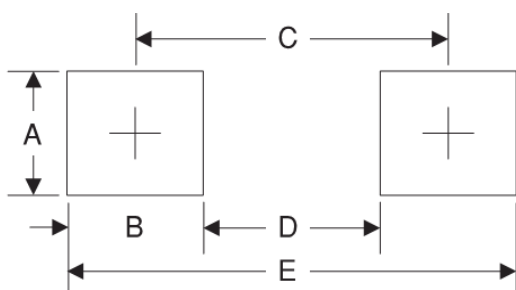
PACKAGE OUTLINE DIMENSIONS

DO-214AA (SMB)



DIM.	Unit (mm)		Unit (inch)	
	Min	Max	Min	Max
A	1.95	2.10	0.077	0.083
B	4.25	4.75	0.167	0.187
C	3.48	3.73	0.137	0.147
D	1.99	2.61	0.078	0.103
E	0.90	1.41	0.035	0.056
F	5.10	5.30	0.201	0.209
G	0.10	0.20	0.004	0.008
H	0.15	0.31	0.006	0.012

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
A	2.3	0.091
B	2.5	0.098
C	4.3	0.169
D	1.8	0.071
E	6.8	0.268

MARKING DIAGRAM



- P/N = Specific Device Code
- G = Green Compound
- YW = Date Code
- F = Factory Code

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